

Processing/Physical Characteristics	dry / cond	Unit	Test Standard
<b>ISO Data</b>			
<sup>[C]</sup> Molding shrinkage, parallel	1.7 / *	%	ISO 294-4, 2577
<sup>[C]</sup> Molding shrinkage, normal	1.7 / *	%	ISO 294-4, 2577

[C]: CAMPUS

Mechanical properties	dry / cond	Unit	Test Standard
<b>ISO Data</b>			
<sup>[C]</sup> Tensile Modulus	3200 / 1400	MPa	ISO 527
<sup>[C]</sup> Stress at 50% strain	* / 40	MPa	ISO 527
<sup>[C]</sup> Stress at break	60 / *	MPa	ISO 527
<sup>[C]</sup> Strain at break	50 / >50	%	ISO 527
Flexural modulus, 23°C	3000 / 1300	MPa	ISO 178
Flexural strength	120 / 50	MPa	ISO 178
<sup>[C]</sup> Charpy notched impact strength, +23°C	5 / 10	kJ/m <sup>2</sup>	ISO 179/1eA

[C]: CAMPUS

Thermal properties	dry / cond	Unit	Test Standard
<b>ISO Data</b>			
<sup>[C]</sup> Melting temperature, 10°C/min	263 / *	°C	ISO 11357-1/-3
<sup>[C]</sup> Temp. of deflection under load, 1.80 MPa	65 / *	°C	ISO 75-1/-2
<sup>[C]</sup> Temp. of deflection under load, 0.45 MPa	205 / *	°C	ISO 75-1/-2
<sup>[C]</sup> Burning Behav. at 1.5 mm nom. thickn.	V-2 / *	class	IEC 60695-11-10
Yellow Card available	yes / *	-	-
<sup>[C]</sup> Burning Behav. at thickness h	V-2 / *	class	IEC 60695-11-10
Thickness tested	0.8 / *	mm	-

[C]: CAMPUS

Electrical properties	dry / cond	Unit	Test Standard
<b>ISO Data</b>			
<sup>[C]</sup> Volume resistivity	1E13 / -	Ohm*m	IEC 62631-3-1
<sup>[C]</sup> Surface resistivity	* / >1E15	Ohm	IEC 62631-3-2
<sup>[C]</sup> Electric strength	22 / -	kV/mm	IEC 60243-1
<sup>[C]</sup> Comparative tracking index	600 / -	-	IEC 60112

[C]: CAMPUS

Other properties	dry / cond	Unit	Test Standard
<sup>[C]</sup> Density	1140 / -	kg/m <sup>3</sup>	ISO 1183

[C]: CAMPUS

## Characteristics

### Processing

Injection Molding

### Applications

Electrical and Electronical

### Delivery form

Natural Color